

No.: IRV1.PAU.53

Patent Application

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Pepe, et al.

Serial No.:

09/938,686

Filed:

October 30, 2001

STACKABLE LAYERS CONTAINING **ENCAPSULATED INTEGRATED**

CIRCUIT CHIPS WITH ONE OR MORE OVERLYING INTERCONNECT

LAYERS AND A METHOD OF

MAKING THE SAME

Examiner:

Vu, Hung K.

Art Unit:

2811

May 15, 2003

Irvine, California

REQUEST FOR TWO-MONTH EXTENSION OF TIME

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Applicant requests a two-month extension of time from March 19, 2003 to May 19, 2003 to respond to the Office Action of December 19, 2002.

Our check in the amount of \$205.00 to cover the fee for such an extension of time is enclosed. Applicant is entitled to small entity status.

Please charge any additional fees to our Deposit Account No. 01-1960. One copy of this letter is enclosed for such purpose.

Certificate of Mailing

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on May 15, 2003.

By Angela Williams

Signature May

Respectfully submitted,

Joseph C. Andras

Registration No. 33,469

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